### STP4LN80K5



# N-channel 800 V, 2.1 Ω typ.,3 A MDmesh™ K5 Power MOSFET in a TO-220 package

Datasheet - production data

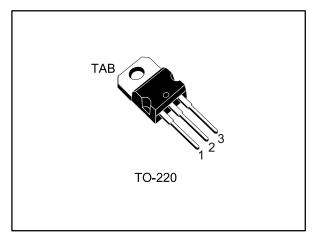
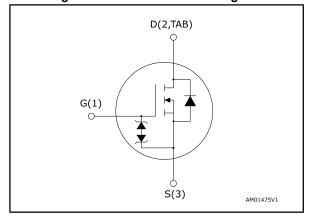


Figure 1: Internal schematic diagram



#### **Features**

Order code	V <sub>DS</sub>	R <sub>DS(on)</sub> max.	ix. I <sub>D</sub>	
STP4LN80K5	800 V	2.6 Ω	3 A	

- Industry's lowest R<sub>DS(on)</sub> \* area
- Industry's best figure of merit (FoM)
- Ultra low-gate charge
- 100% avalanche tested
- Zener-protected

### **Applications**

• Switching applications

### **Description**

This very high voltage N-channel Power MOSFET is designed using MDmesh™ K5 technology based on an innovative proprietary vertical structure. The result is a dramatic reduction in on-resistance and ultra-low gate charge for applications requiring superior power density and high efficiency.

Table 1: Device summary

Order code	Marking	Package	Packing
STP4LN80K5	4LN80K5	TO-220	Tube

Contents STP4LN80K5

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STP4LN80K5 Electrical ratings

## 1 Electrical ratings

Table 2: Absolute maximum ratings

Symbol	Parameter	Value	Unit
V <sub>G</sub> s	Gate-source voltage	± 30	V
I <sub>D</sub>	Drain current (continuous) at T <sub>C</sub> = 25 °C	3	Α
I <sub>D</sub>	Drain current (continuous) at T <sub>C</sub> = 100 °C	1.9	Α
I <sub>D</sub> <sup>(1)</sup>	Drain current (pulsed)	12	Α
P <sub>TOT</sub>	Total dissipation at T <sub>C</sub> = 25 °C	60	W
dv/dt <sup>(2)</sup>	Peak diode recovery voltage slope	15	V/ns
dv/dt <sup>(3)</sup>	MOSFET dv/dt ruggedness	50	
Tj	Operating junction temperature range	FF to 150	°C
T <sub>stg</sub>	Storage temperature range	- 55 to 150	

#### Notes:

Table 3: Thermal data

Symbol	Parameter	Value	Unit
R <sub>thj-case</sub>	Thermal resistance junction-case	2.08	°C/W
R <sub>thj-amb</sub>	Thermal resistance junction-ambient	62.5	°C/W

**Table 4: Avalanche characteristics** 

Symbol	Parameter	Value	Unit
I <sub>AR</sub>	Avalanche current, repetitive or not repetitive (pulse width limited by T <sub>jmax</sub> )	0.8	А
Eas	Single pulse avalanche energy (starting $T_j = 25$ °C, $I_D = I_{AR}$ , $V_{DD} = 50$ V)	160	mJ

<sup>&</sup>lt;sup>(1)</sup>Pulse width limited by safe operating area

 $<sup>^{(2)}</sup>I_{SD} \leq 3$  A, di/dt 100 A/µs; VDs peak <  $V_{(BR)DSS},~V_{DD} = 400~V.$ 

 $<sup>^{(3)}</sup>V_{DS} \le 640 \text{ V}$ 

Electrical characteristics STP4LN80K5

### 2 Electrical characteristics

T<sub>C</sub> = 25 °C unless otherwise specified

Table 5: On/off-state

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
V <sub>(BR)DSS</sub>	Drain-source breakdown voltage	$V_{GS} = 0 \text{ V}, I_D = 1 \text{ mA}$	800			V
		V <sub>GS</sub> = 0 V, V <sub>DS</sub> = 800 V			1	μΑ
I <sub>DSS</sub>	Zero gate voltage drain current	$V_{GS} = 0 \text{ V}, V_{DS} = 800 \text{ V}$ $T_{C} = 125 \text{ °C}^{(1)}$			50	μΑ
I <sub>GSS</sub>	Gate body leakage current	$V_{DS} = 0 \text{ V}, V_{GS} = \pm 20 \text{ V}$			± 10	μΑ
V <sub>GS(th)</sub>	Gate threshold voltage	$V_{DD} = V_{GS}$ , $I_D = 100 \mu A$	3	4	5	V
R <sub>DS(on)</sub>	Static drain-source on-resistance	$V_{GS} = 10 \text{ V}, I_D = 1 \text{ A}$		2.1	2.6	Ω

#### Notes:

**Table 6: Dynamic** 

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit	
Ciss	Input capacitance		-	122	-	pF	
Coss	Output capacitance	$V_{DS} = 100 \text{ V}, f = 1 \text{ MHz},$ $V_{GS} = 0 \text{ V}$	-	11	-	pF	
Crss	Reverse transfer capacitance	VG3 - 0 V	-	0.3	-	pF	
Co(tr) <sup>(1)</sup>	Equivalent capacitance time related	V <sub>DS</sub> = 0 to 640 V,	-	23	-	pF	
C <sub>o(er)</sub> <sup>(2)</sup>	Equivalent capacitance energy related	V <sub>G</sub> S = 0 V	-	9	-	pF	
Rg	Intrinsic gate resistance	f = 1 MHz, Id = 0 A	-	18	-	Ω	
Qg	Total gate charge	$V_{DD} = 640 \text{ V}, I_D = 2.5 \text{ A}$	-	3.7	-	nC	
Q <sub>gs</sub>	Gate-source charge	V <sub>GS</sub> = 10 V	-	1	-	nC	
Q <sub>gd</sub>	Gate-drain charge	(see Figure 15: "Test circuit for gate charge behavior")	-	2.2	-	nC	

#### Notes:

 $<sup>^{\</sup>left( 1\right) }$  Defined by design, not subject to production test.

 $<sup>^{(1)}</sup>$  Time related is defined as a constant equivalent capacitance giving the same charging time as  $C_{oss}$  when  $V_{DS}$  increases from 0 to 80%  $V_{DSS}$ .

 $<sup>^{(2)}</sup>$  Energy related is defined as a constant equivalent capacitance giving the same stored energy as  $C_{oss}$  when  $V_{DS}$  increases from 0 to 80%  $V_{DSS}$ .

Table 7: Switching times

Table 7. Owtering times							
Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit	
t <sub>d(on)</sub>	Turn-on delay time	V <sub>DD</sub> = 400 V, I <sub>D</sub> = 1.25 A,	-	7	-	ns	
tr	Rise time	$R_G = 4.7 \Omega$	-	9	-	ns	
t <sub>d(off)</sub>	Turn-off delay time	$V_{GS} = 10 \text{ V}$	-	31	-	ns	
t <sub>f</sub>	Fall time	(see Figure 14: "Test circuit for resistive load switching times" and Figure 19: "Switching time waveform")	-	25	-	ns	

Table 8: Source-drain diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
I <sub>SD</sub>	Source-drain current		-		3	Α
I <sub>SDM</sub> <sup>(1)</sup>	Source-drain current (pulsed)		-		12	Α
V <sub>SD</sub> <sup>(2)</sup>	Forward on voltage	I <sub>SD</sub> = 2.5 A, V <sub>GS</sub> = 0 V	-		1.6	V
t <sub>rr</sub>	Reverse recovery time	$I_{SD} = 2.5 \text{ A}, \text{ di/dt} = 100 \text{ A/}\mu\text{s},$	-	230		ns
Q <sub>rr</sub>	Reverrse recovery charge	V <sub>DD</sub> = 60 V (see Figure 16: "Test circuit for inductive load switching and diode recovery times")		1.04		μC
I <sub>RRM</sub>	Reverse recovery current			9		Α
trr	Reverse recovery time	I <sub>SD</sub> = 2.5 A, di/dt = 100 A/μs		368		ns
Qrr	Reverse recovery charge	V <sub>DD</sub> = 60 V, T <sub>j</sub> = 150 °C (see <i>Figure 16: "Test circuit for</i>	-	1.53		μC
I <sub>RRM</sub>	Reverse recovery current	inductive load switching and diode recovery times")		8		А

#### Notes:

Table 9: Gate-source Zener diode

Symbol	Parameter	Test conditions	Min.	Тур.	Max.	Unit
$V_{(BR)GSO}$	Gate-source breakdown voltage	$I_{GS} = \pm 1 \text{ mA}, I_{D} = 0 \text{ A}$	30	ı	-	V

The built-in back-to-back Zener diodes are specifically designed to enhance the ESD performance of the device. The Zener voltage facilitates efficient and cost-effective device integrity protection, thus eliminating the need for additional external componentry.

<sup>&</sup>lt;sup>(1)</sup>Pulse width limited by safe operating area

 $<sup>^{(2)}</sup>$ Pulsed: pulse duration = 300  $\mu$ s, duty cycle 1.5%

## 2.1 Electrical characteristics (curves)

Figure 2: Safe operating area  $\begin{pmatrix} I_D \\ (A) \end{pmatrix}$   $\begin{pmatrix} I_D \\ (A) \end{pmatrix}$ 

Figure 3: Thermal impedance  $K \\ \delta = 0.5$   $\delta = 0.2$   $\delta = 0.1$   $\delta = 0.1$   $\delta = 0.05$   $\delta = t_p/T$   $\delta = 0.02$   $\delta = 0.01$ SINGLE PULSE  $10^{-2}$   $10^{-5}$   $10^{-4}$   $10^{-3}$   $10^{-2}$   $10^{-1}$   $t_p(s)$ 

Figure 4: Output characteristics

ID GIPD0605201612260CH

(A)

V<sub>GS</sub> = 11 V

V<sub>GS</sub> = 10 V

V<sub>GS</sub> = 8 V

V<sub>GS</sub> = 7 V

1

0

4

V<sub>GS</sub> = 6 V

0

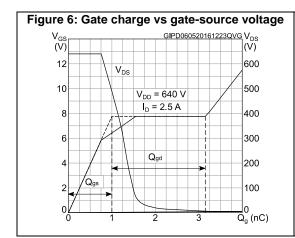
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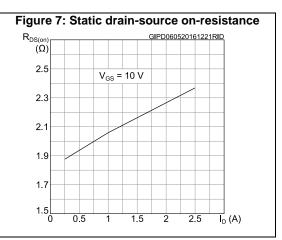
8

12

16

V<sub>DS</sub>(V)





STP4LN80K5 Electrical characteristics

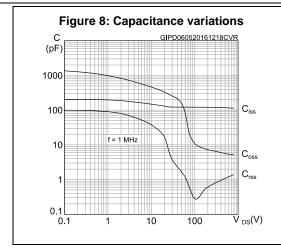
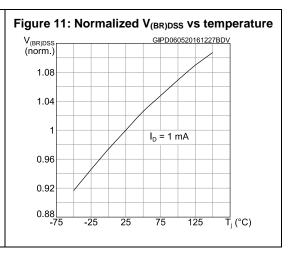
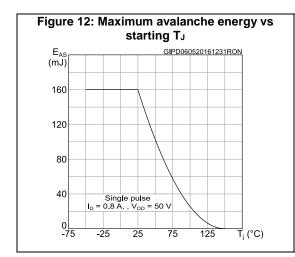
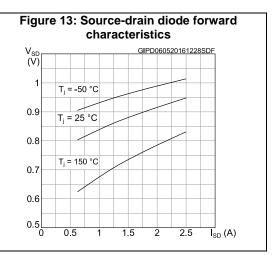


Figure 10: Normalized on-resistance vs temperature

R<sub>DS(on)</sub> GIPD060520161229RON
(norm.)
2.6
2.2
1.8
V<sub>GS</sub> = 10 V
1.4
1
0.6
0.2
-75 -25 25 75 125 T<sub>j</sub> (°C)







Test circuits STP4LN80K5

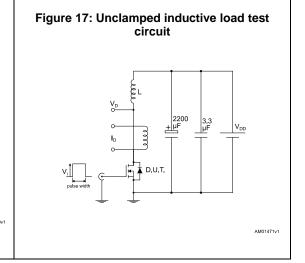
### 3 Test circuits

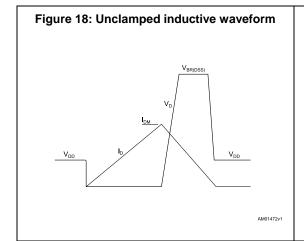
Figure 14: Test circuit for resistive load switching times

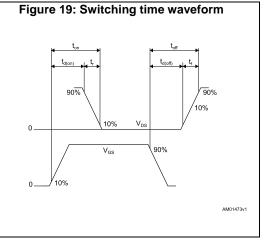
Figure 15: Test circuit for gate charge behavior

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Figure 16: Test circuit for inductive load switching and diode recovery times







STP4LN80K5 Package information

## 4 Package information

In order to meet environmental requirements, ST offers these devices in different grades of ECOPACK® packages, depending on their level of environmental compliance. ECOPACK® specifications, grade definitions and product status are available at: **www.st.com**. ECOPACK® is an ST trademark.



## 4.1 TO-220 type A package information

Figure 20: TO-220 type A package outline

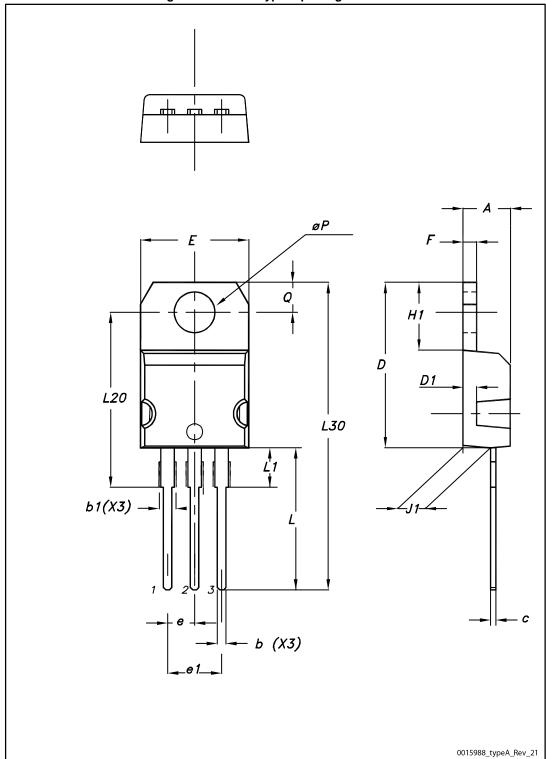


Table 10: TO-220 type A mechanical data

Dim		mm	
Dim.	Min.	Тур.	Max.
А	4.40		4.60
b	0.61		0.88
b1	1.14		1.55
С	0.48		0.70
D	15.25		15.75
D1		1.27	
Е	10.00		10.40
е	2.40		2.70
e1	4.95		5.15
F	1.23		1.32
H1	6.20		6.60
J1	2.40		2.72
L	13.00		14.00
L1	3.50		3.93
L20		16.40	
L30		28.90	
øΡ	3.75		3.85
Q	2.65		2.95

Revision history STP4LN80K5

## 5 Revision history

**Table 11: Document revision history** 

Date	Revision	Changes
20-May-2015	1	First release.
18-May-2016	2	Document status promoted from preliminary data to production data.  Updated Figure 1: "Internal schematic diagram".  Updated Section 1: "Electrical ratings", Section 2: "Electrical characteristics".  Added Section 2.1: "Electrical characteristics (curves)".  Updated Section 3: "Test circuits".  Minor text changes.

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